

15 JUL 1983

Smith, Hinchman & Grylls Associates, Inc.  
455 West Fort Street  
Detroit, Michigan 48226

Attention: Mr. Wm. Everett Medling

Gentlemen:

Per your request, we are enclosing under separate cover  
one copy of Volumes 1 and 2 of MIL-HDBK-419, Grounding,  
Bonding, and Shielding for Electronic Equipment and  
Facilities dated 21 January 1982.

Sincerely,

[Redacted Signature]

New Building Project Office  
Office of Logistics

Enclosure  
under separate cover

Distribution:  
Orig - Adse  
✓ - OL/NBPO

OL/NBPO [Redacted] (15 July 83)  
hand-carried to Detroit by Mr. Medling

[Redacted Content]